

X7R Dielectric

General Specifications



X7R formulations are called "temperature stable" ceramics and fall into EIA Class II materials. X7R is the most popular of these intermediate dielectric constant materials. Its temperature variation of capacitance is within $\pm 15\%$ from -55°C to $+125^{\circ}\text{C}$. This capacitance change is non-linear.

Capacitance for X7R varies under the influence of electrical operating conditions such as voltage and frequency.

X7R dielectric chip usage covers the broad spectrum of industrial applications where known changes in capacitance due to applied voltages are acceptable.



PART NUMBER (see page 2 for complete part number explanation)

0805	5	C	103	M	A	T	2	A
Size (L" x W")	Voltage 4V = 4 6.3V = 6 10V = Z 16V = Y 25V = 3 50V = 5 100V = 1 200V = 2 500V = 7	Dielectric X7R = C	Capacitance Code (In pF) 2 Sig. Digits + Number of Zeros	Capacitance Tolerance J = $\pm 5\%$ * K = $\pm 10\%$ M = $\pm 20\%$ * $\leq 1\mu\text{F}$ only, contact factory for additional values	Failure Rate A = Not Applicable	Terminations T = Plated Ni and Sn 7 = Gold Plated* Z = FLEXITERM®** *Optional termination **See FLEXITERM® X7R section	Packaging 2 = 7" Reel 4 = 13" Reel 7 = Bulk Cass. 9 = Bulk	Special Code A = Std. Product
							Contact Factory For Multiples	

NOTE: Contact factory for availability of Termination and Tolerance Options for Specific Part Numbers.
Contact factory for non-specified capacitance values.



Specifications and Test Methods

Parameter/Test		X7R Specification Limits	Measuring Conditions	
Operating Temperature Range		-55°C to +125°C	Temperature Cycle Chamber	
Capacitance		Within specified tolerance	Freq.: 1.0 kHz $\pm$ 10% Voltage: 1.0Vrms $\pm$.2V	
Dissipation Factor		$\leq 2.5\%$ for $\geq 50V$ DC rating $\leq 3.0\%$ for 25V DC rating $\leq 3.5\%$ for 25V and 16V DC rating $\leq 5.0\%$ for $\leq 10V$ DC rating		
Insulation Resistance		100,000M Ω or 1000M Ω - μ F, whichever is less	Charge device with rated voltage for 120 $\pm$ 5 secs @ room temp/humidity	
Dielectric Strength		No breakdown or visual defects	Charge device with 300% of rated voltage for 1-5 seconds, w/charge and discharge current limited to 50 mA (max) Note: Charge device with 150% of rated voltage for 500V devices.	
Resistance to Flexure Stresses	Appearance	No defects	Deflection: 2mm Test Time: 30 seconds  1mm/sec 90 mm	
	Capacitance Variation	$\leq \pm 12\%$		
	Dissipation Factor	Meets Initial Values (As Above)		
	Insulation Resistance	$\geq$ Initial Value x 0.3		
Solderability		$\geq 95\%$ of each terminal should be covered with fresh solder	Dip device in eutectic solder at 230 $\pm$ 5°C for 5.0 $\pm$ 0.5 seconds	
Resistance to Solder Heat	Appearance	No defects, <25% leaching of either end terminal	Dip device in eutectic solder at 260°C for 60 seconds. Store at room temperature for 24 $\pm$ 2 hours before measuring electrical properties.	
	Capacitance Variation	$\leq \pm 7.5\%$		
	Dissipation Factor	Meets Initial Values (As Above)		
	Insulation Resistance	Meets Initial Values (As Above)		
	Dielectric Strength	Meets Initial Values (As Above)		
Thermal Shock	Appearance	No visual defects	Step 1: -55°C $\pm$ 2°	30 $\pm$ 3 minutes
	Capacitance Variation	$\leq \pm 7.5\%$	Step 2: Room Temp	≤ 3 minutes
	Dissipation Factor	Meets Initial Values (As Above)	Step 3: +125°C $\pm$ 2°	30 $\pm$ 3 minutes
	Insulation Resistance	Meets Initial Values (As Above)	Step 4: Room Temp	≤ 3 minutes
	Dielectric Strength	Meets Initial Values (As Above)	Repeat for 5 cycles and measure after 24 $\pm$ 2 hours at room temperature	
Load Life	Appearance	No visual defects	Charge device with 1.5 rated voltage ($\leq 10V$) in test chamber set at 125°C $\pm$ 2°C for 1000 hours (+48, -0) Remove from test chamber and stabilize at room temperature for 24 $\pm$ 2 hours before measuring.	
	Capacitance Variation	$\leq \pm 12.5\%$		
	Dissipation Factor	$\leq$ Initial Value x 2.0 (See Above)		
	Insulation Resistance	$\geq$ Initial Value x 0.3 (See Above)		
	Dielectric Strength	Meets Initial Values (As Above)		
Load Humidity	Appearance	No visual defects	Store in a test chamber set at 85°C $\pm$ 2°C/ 85% $\pm$ 5% relative humidity for 1000 hours (+48, -0) with rated voltage applied. Remove from chamber and stabilize at room temperature and humidity for 24 $\pm$ 2 hours before measuring.	
	Capacitance Variation	$\leq \pm 12.5\%$		
	Dissipation Factor	$\leq$ Initial Value x 2.0 (See Above)		
	Insulation Resistance	$\geq$ Initial Value x 0.3 (See Above)		
	Dielectric Strength	Meets Initial Values (As Above)		

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Capacitance Range



PREFERRED SIZES ARE SHADED

SIZE		0101*	0201	0402	0603	0805	1206
Soldering		Reflow Only	Reflow Only	Reflow/Wave	Reflow/Wave	Reflow/Wave	Reflow/Wave
Packaging		Paper/Embossed	All Paper	All Paper	All Paper	Paper/Embossed	Paper/Embossed
(L) Length	mm (in.)	0.40 ± 0.02 (0.016 ± 0.0008)	0.60 ± 0.03 (0.024 ± 0.001)	1.00 ± 0.10 (0.040 ± 0.004)	1.60 ± 0.15 (0.063 ± 0.006)	2.01 ± 0.20 (0.079 ± 0.008)	3.20 ± 0.20 (0.126 ± 0.008)
(W) Width	mm (in.)	0.20 ± 0.02 (0.008 ± 0.0008)	0.30 ± 0.03 (0.011 ± 0.001)	0.50 ± 0.10 (0.020 ± 0.004)	0.81 ± 0.15 (0.032 ± 0.006)	1.25 ± 0.20 (0.049 ± 0.008)	1.60 ± 0.20 (0.063 ± 0.008)
(t) Terminal	mm (in.)	0.20 ± 0.02 (0.008 ± 0.0008)	0.15 ± 0.05 (0.006 ± 0.002)	0.25 ± 0.15 (0.010 ± 0.006)	0.35 ± 0.15 (0.014 ± 0.006)	0.50 ± 0.25 (0.020 ± 0.010)	0.50 ± 0.25 (0.020 ± 0.010)
WVDC		10	10 16 25 50	6.3 10 16 25 50	6.3 10 16 25 50 100 200	6.3 10 16 25 50 100 200	6.3 10 16 25 50 100 200 500
Cap	100 101	A	A A A A A	C C	G G G		
(pF)	150 151	A	A A A A A	C C	G G G		
	220 221	A	A A A A A	C C	G G G		
	330 331	A	A A A A A	C C	G G G	J J J J J J	
	470 471	A	A A A A A	C C	G G G	J J J J J J	K
	680 681	A	A A A A	C C	G G G	J J J J J J	K
	1000 102	A	A A A	C C C	G G G	J J J J J J	K
	1500 152		A A	C C C	G G	J J J J J J	J J J J J J M
	2200 222		A A	C C C	G G	J J J J J J	J J J J J J M
	3300 332		A A	C C C	G G	J J J J J J	J J J J J J M
	4700 472		A A	C C C	G G	J J J J J J	J J J J J J M
	6800 682		A A	C C C	G G	J J J J J J	J J J J J J P
Cap	0.01 103		A A	C C C	G G G	J J J J J J	J J J J J J P
(µF)	0.015 153			C C C	G G G	J J J J J J	J J J J J J M
	0.022 223			C C C	G G G	J J J J J J N	J J J J J J M
	0.033 333			C C C	G G	J J J J J J	J J J J J J M
	0.047 473			C C C	G G G	J J J J J N	J J J J J M
	0.068 683			C C C	G G G	J J J J J N	J J J J J P
	0.1 104			C C C	G G G G	J J J J J N	J J J J J M P
	0.15 154				G G G G G	J J J J N N	J J J J Q
	0.22 224				G G J J	J J N N N	J J J J Q
	0.33 334				J J J J J	N N N N N	J J M P Q
	0.47 474				J J J J J	N N N N N	M M M P Q
	0.68 684				J J J J	N N N	M M Q Q Q
	1.0 105			C	J J J J	N N N N	M M Q Q Q
	2.2 225				J J	P P P P	Q Q Q Q Q
	4.7 475					P P P	Q Q Q Q
	10 106					P P	Q Q Q
	22 226						Q Q
	47 476						
	100 107						
WVDC		10	10 16 25 50	6.3 10 16 25 50	6.3 10 16 25 50 100 200	6.3 10 16 25 50 100 200	6.3 10 16 25 50 100 200 500
SIZE		0101	0201	0402	0603	0805	1206

Letter	A	B	C	E	G	J	K	M	N	P	Q	X	Y	Z
Max. Thickness	0.33 (0.013)	0.22 (0.009)	0.56 (0.022)	0.71 (0.028)	0.90 (0.035)	0.94 (0.037)	1.02 (0.040)	1.27 (0.050)	1.40 (0.055)	1.52 (0.060)	1.78 (0.070)	2.29 (0.090)	2.54 (0.100)	2.79 (0.110)
PAPER							EMBOSS							

NOTE: Contact factory for non-specified capacitance values

*EIA 01005



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Capacitance Range



PREFERRED SIZES ARE SHADED

SIZE		1210							1812							1825			2220					2225			
Soldering		Reflow Only							Reflow Only							Reflow Only			Reflow Only					Reflow Only			
Packaging		Paper/Embossed							All Embossed							All Embossed			All Embossed					All Embossed			
(L) Length	mm (in.)	3.20 ± 0.20 (0.126 ± 0.008)							4.50 ± 0.30 (0.177 ± 0.012)							4.50 ± 0.30 (0.177 ± 0.012)			5.70 ± 0.40 (0.225 ± 0.016)					5.72 ± 0.25 (0.225 ± 0.010)			
(W) Width	mm (in.)	2.50 ± 0.20 (0.098 ± 0.008)							3.20 ± 0.20 (0.126 ± 0.008)							6.40 ± 0.40 (0.252 ± 0.016)			5.00 ± 0.40 (0.197 ± 0.016)					6.35 ± 0.25 (0.250 ± 0.010)			
(t) Terminal	mm (in.)	0.50 ± 0.25 (0.020 ± 0.010)							0.61 ± 0.36 (0.024 ± 0.014)							0.61 ± 0.36 (0.024 ± 0.014)			0.64 ± 0.39 (0.025 ± 0.015)					0.64 ± 0.39 (0.025 ± 0.015)			
	WVDC	10	16	25	50	100	200	500	16	25	50	100	200	500	50	100	200	25	50	100	200	500	50	100	200		
Cap	100	101																									
(pF)	150	151																									
	220	221																									
	330	331																									
	470	471																									
	680	681																									
	1000	102																									
	1500	152	J	J	J	J	J	J	M																		
	2200	222	J	J	J	J	J	J	M																		
	3300	332	J	J	J	J	J	J	M																		
	4700	472	J	J	J	J	J	J	M																		
	6800	682	J	J	J	J	J	J	M																		
Cap	0.01	103	J	J	J	J	J	J	M			K	K	K	K	P	M	M	M		X	X	X	X	M	P	P
(μF)	0.015	153	J	J	J	J	J	J	P			K	K	K	K	P	M	M	M		X	X	X	X	M	P	P
	0.022	223	J	J	J	J	J	J	Q			K	K	K	K	P	M	M	M		X	X	X	X	M	P	P
	0.033	333	J	J	J	J	J	J	Q			K	K	K	K	X	M	M	M		X	X	X	X	M	P	P
	0.047	473	J	J	J	J	J	J	Q			K	K	K	K	Z	M	M	M		X	X	X	X	M	P	P
	0.068	683	J	J	J	J	J	M	Q			K	K	K	K	Z	M	M	M		X	X	X	X	M	P	P
	0.1	104	J	J	J	J	J	M				K	K	K	K	Z	M	M	M		X	X	X	X	M	P	P
	0.15	154	J	J	J	J	M	Z				K	K	K	P	Z	M	M	M		X	X	X	X	M	P	X
	0.22	224	J	J	J	J	P	Z				K	K	K	P		M	M	M		X	X	X	X	M	P	X
	0.33	334	J	J	J	J	Q					K	K	M	X		M	M			X	X	X	X	M	P	X
	0.47	474	M	M	M	M	Q					K	K	P			M	M			X	X	X	X	M	P	X
	0.68	684	M	M	P	X	X					M	M	Q			M	P			X	X			M	P	X
	1.0	105	N	N	P	X	Z					M	M	X	Z		M	P			X	X			M	P	X
	1.5	155	N	N	Z	Z	Z					Z	Z	Z			M				X	X			M	X	
	2.2	225	X	X	Z	Z	Z					Z	Z	Z							X	X			M	X	
	3.3	335	X	X	Z	Z						Z	Z	Z							X	Z					
	4.7	475	X	X	Z	Z						Z	Z								X	Z					
	10	106	Z	Z	Z	Z						Z									Z	Z					
	22	226	Z	Z	Z																						
	47	476	Z																								
	100	107																									
	WVDC	10	16	25	50	100	200	500	16	25	50	100	200	500	50	100	200	25	50	100	200	500	50	100	200		
SIZE		1210							1812							1825			2220					2225			
Letter Max. Thickness		A 0.33 (0.013)	B 0.22 (0.009)	C 0.56 (0.022)	E 0.71 (0.028)	G 0.90 (0.035)	J 0.94 (0.037)		K 1.02 (0.040)	M 1.27 (0.050)	N 1.40 (0.055)	P 1.52 (0.060)	Q 1.78 (0.070)	X 2.29 (0.090)	Y 2.54 (0.100)	Z 2.79 (0.110)											
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NOTE: Contact factory for non-specified capacitance values